

HIKER UDIMM DDR3

Introduction

HIKSEMI HIKER UDIMM DDR3 memory module is made of high-quality DRAM chips and mature production technology, which makes it more compatible, stable and cost-effective. It can be widely used in PC installations and various high-bandwidth, high-performance system applications.



Features

- Cost-effective

Adopt selected IC to make the system run stably and perform better.

- Good compatibility

Better compatibility, compatible with more products after HIKSEMI optimization.

Ordering Information

Frequency	Capacity	Model
1600	4GB	HSC304U16Z1 4G
	8GB	HSC308U16Z1 8G



Please contact the local sales for detailed model information.

Specification

Name	HIKER UDIMM DDR3
Capacity	4GB 8GB
Interface	DDR3
Frequency	1600MHz
Pin	240pin
PCB Size (L×W×H mm)	133.4*30.0*3.2
Operation temperature	0 °C to 85 °C (32 °F to 185 °F)
Limited warranty period	Lifetime warranty
Weight	15g

Revision History

Version	Description	Date
V1.0.0	HIKER series: HS-UDIMM-U1	20260108

Data subject to change without notice.

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The Manual includes instructions for using and managing the Product. Pictures, charts, images and all other information hereinafter are for description and explanation only. The information contained in the Manual is subject to change,without notice, due to firmware updates or other reasons. Please find the latest version of this Manual at the HIKSTORAGE website (www.hiksemitech.com).